QUXY2.E240000
Process Control Equipment, Electrical - Component

See General Information for Process Control Equipment, Electrical - Component

BRISKHEAT CORPORATION
4800 Hilton Corporate Dr
Columbus, OH 43232 USA

Process control, Model CENTMOD-xxx, where each x may be any alphanumeric character.
1. The transducer is intended for panel mounting. Only the front portion of the overall enclosure has been evaluated as the ultimate enclosure.
2. The terminals of the panel mounted device are suitable for field connection. Use wiring rated for at least 75°C.
3. The device is suitable for use in a 65°C ambient.

Centipede 2 Control Module Unit, Model CZMOD-C, 916593.
Process control, PCB Assembly Part Number 30049607.
1. The PCB Assembly is required to be completely enclosed within an industrial control panel or similar enclosure.
2. The terminals of the PWB Assembly are suitable for factory wiring only.
3. The device is suitable for operation at a maximum 55°C.

Markings: Company name, type designation and the Recognized Component Marking.

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Signature: [Signature]
Full Name: Douglas R. Dietz
Position: Vice President of Engineering